















ESD

TVS

MOS

LDO

Diode

Sensor

DC-DC

Product Specification

Domestic Part Number	IRF2807
Overseas Part Number	IRF2807
▶ Equivalent Part Number	IRF2807





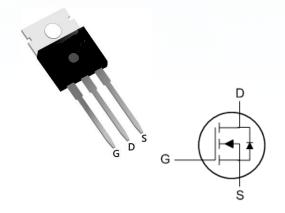
- ★ Super Low Gate Charge
- ★ 100% EAS Guaranteed
- ★ Green Device Available
- ★ Excellent CdV/dt effect decline
- ★ Advanced high cell density Trench technology

Description TO220 Pin Configuration

The IRF2807 is the high cell density trenched N-ch MOSFETs, which provide excellent RDSON and gate charge for most of the synchronous buck converter applications.

The IRF2807 meet the RoHS and Green Product requirement, 100% EAS guaranteed with full function reliability approved.





Product Summary

Absolute Maximum Ratings

Symbol	Parameter	Rating	Units
V _{DS}	Drain-Source Voltage	80	V
V _{GS}	Gate-Source Voltage	±20	V
I _D @T _C =25°C	Continuous Drain Current ¹	100	Α
I _D @T _C =100°C	Continuous Drain Current ¹	70	Α
I _{DM}	Pulsed Drain Current ²	200	Α
EAS	Single Pulse Avalanche Energy ³	80	mJ
P _D @T _C =25°C	Total Power Dissipation ⁴	89	W
T _{STG}	Storage Temperature Range	-55 to 175	°C
TJ	Operating Junction Temperature Range	-55 to 175	°C

Thermal Data

Symbol	Parameter	Тур.	Max.	Unit
$R_{ heta JA}$	Thermal Resistance Junction-Ambient ¹		62	°C/W
Rejc	Thermal Resistance Junction-Case ¹		0.65	°C/W



Electrical Characteristics (T_J=25 °C, unless otherwise noted)

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
BV _{DSS}	Drain-Source Breakdown Voltage	V _{GS} =0V , I _D =250uA	80			V
R _{DS(ON)}	Static Drain-Source On-Resistance ²	V _{GS} =10V , I _D =20A		9.6	12	mΩ
NDS(ON)		V _{GS} =4.5V, I _D =10A		12	14.5	mΩ
V _{GS(th)}	Gate Threshold Voltage	V _{GS} =V _{DS} , I _D =250uA	1.2		2.5	V
lana	Drain-Source Leakage Current	V _{DS} =64V , V _{GS} =0V , T _J =25°C			1	- uA
I _{DSS}		V _{DS} =64V , V _{GS} =0V , T _J =55°C			5	
Igss	Gate-Source Leakage Current	$V_{GS}=\pm 20V$, $V_{DS}=0V$			±100	nA
gfs	Forward Transconductance	V _{DS} =5V , I _D =10A		32		S
Rg	Gate Resistance	V _{DS} =0V , V _{GS} =0V , f=1MHz		0.66		Ω
Qg	Total Gate Charge (10V)	V 64V V 10V		60.9		
Q _{gs}	Gate-Source Charge	V _{DS} =64V , V _{GS} =10V ,		8.1		nC
Q _{gd}	Gate-Drain Charge	I _D =10A		17.9		
T _{d(on)}	Turn-On Delay Time			12.2		
Tr	Rise Time	V _{DD} =40V , V _{GS} =10V ,		24.5		
T _{d(off)}	Turn-Off Delay Time	R _G =3.3Ω, I _D =10A		50.5		ns
T _f	Fall Time			17.6		
Ciss	Input Capacitance	V _{DS} =50V , V _{GS} =0V , f=1MHz		3120		
Coss	Output Capacitance			140		pF
Crss	Reverse Transfer Capacitance			110		

Diode Characteristics

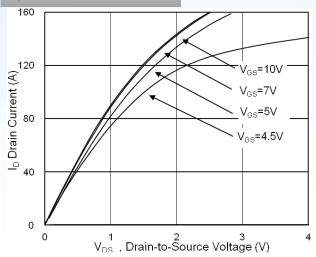
Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
Is	Continuous Source Current ^{1,5}	V _G =V _D =0V , Force Current			100	Α
V _{SD}	Diode Forward Voltage ²	V _G s=0V , I _S =1A , T _J =25°C			1.2	V
t _{rr}	Reverse Recovery Time	IF=10A , dI/dt=100A/μs ,		18.6		nS
Qrr	Reverse Recovery Charge	T _J =25°C		65		nC

Note:

- 1. The data tested by surface mounted on a 1 inch 2 FR-4 board with 2OZ copper.
- 2.The data tested by pulsed , pulse width \leq 300us , duty cycle \leq 2%
- 3. The EAS data shows Max. rating . The test condition is V_{DD} =50V, V_{GS} =10V, L=0.1mH, I_{AS} =40A
- 4.The power dissipation is limited by 175°C junction temperature
- 5. The data is theoretically the same as I_D and I_{DM} , in real applications, should be limited by total power dissipation.



Typical Characteristics



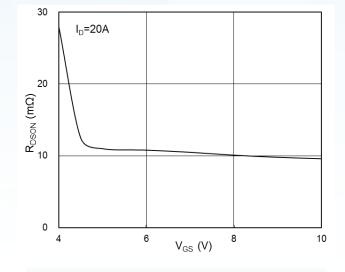
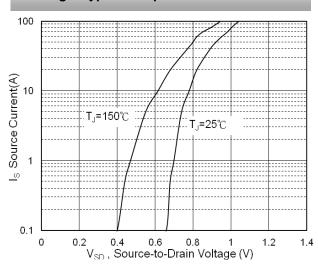


Fig.1 Typical Output Characteristics





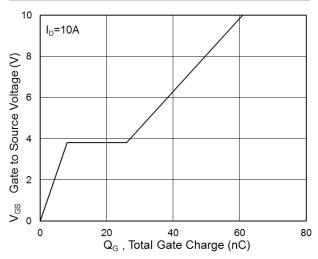


Fig.3 Forward Characteristics of Reverse

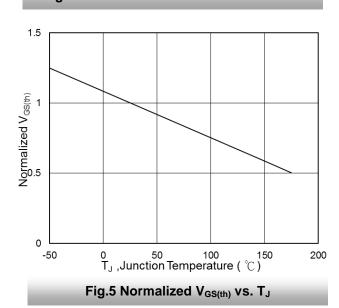


Fig.4 Gate-Charge Characteristics

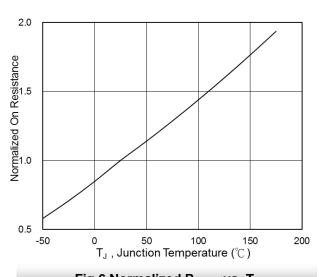
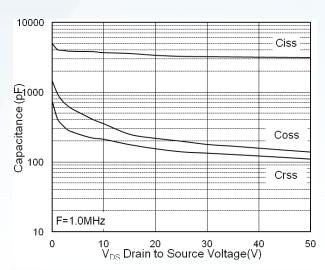
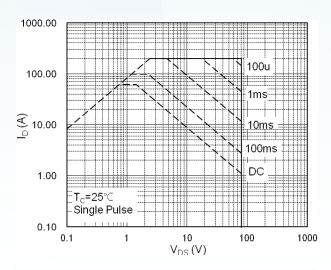


Fig.6 Normalized R_{DSON} vs. T_J







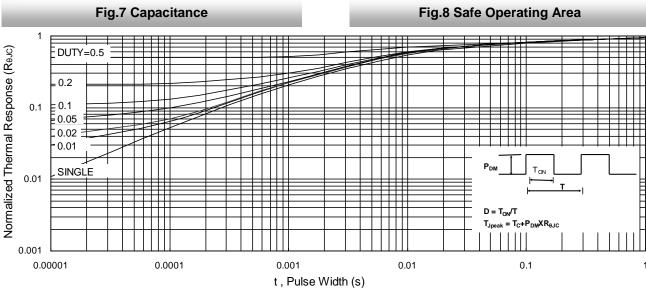
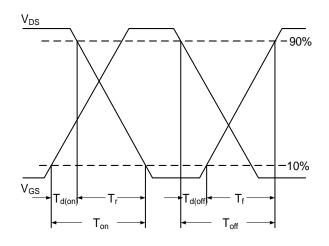
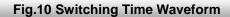


Fig.9 Normalized Maximum Transient Thermal Impedance





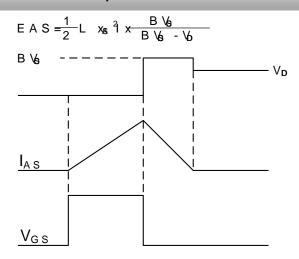


Fig.11 Unclamped Inductive Switching Waveform



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